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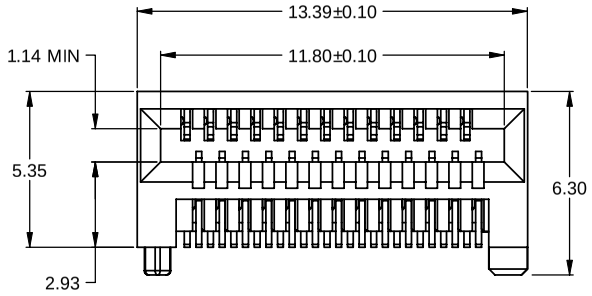
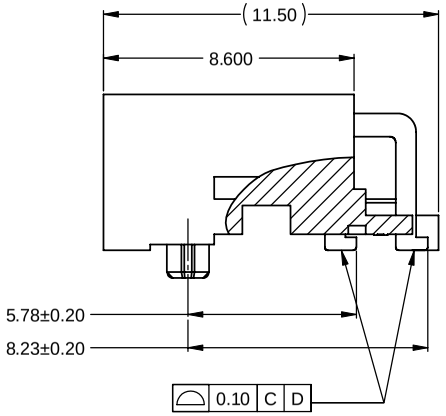
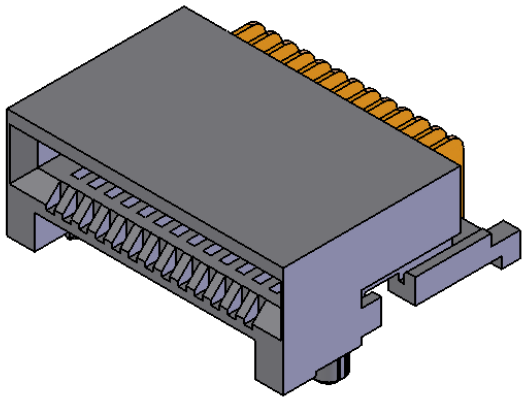
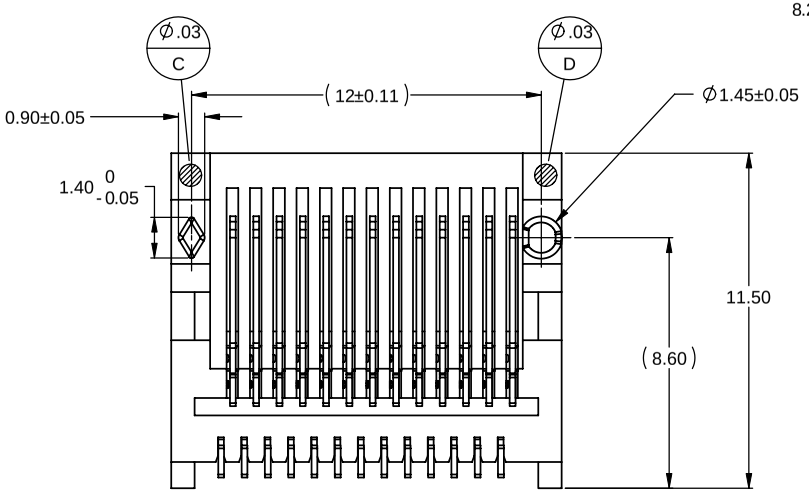
REVISIONS				
REV.	ECN	DESCRIPTION	DATE	APPROVED
C		INITIAL RELEASE	APR 18/06	ML
D		PCB SOLDER PAD WIDTH REVISED FROM .010" TO .014"	FEB 19/07	JLJ
E		TOLERANCE ADDED TO PCB HOLE & LOCATING PIN	FEB 27/07	JLJ
F		FS1-R26-3000 ADDED	APR 05/07	JLJ
G		DIAM. PEG DIM'S. ADDED, TOLERANCE ADDED TO .472	AUG 10/07	JLJ
H		HOUSING MODIFIED	AUG 21/07	JLJ
J		IMPERIAL UNITS REMOVED	OCT 4/07	JLJ

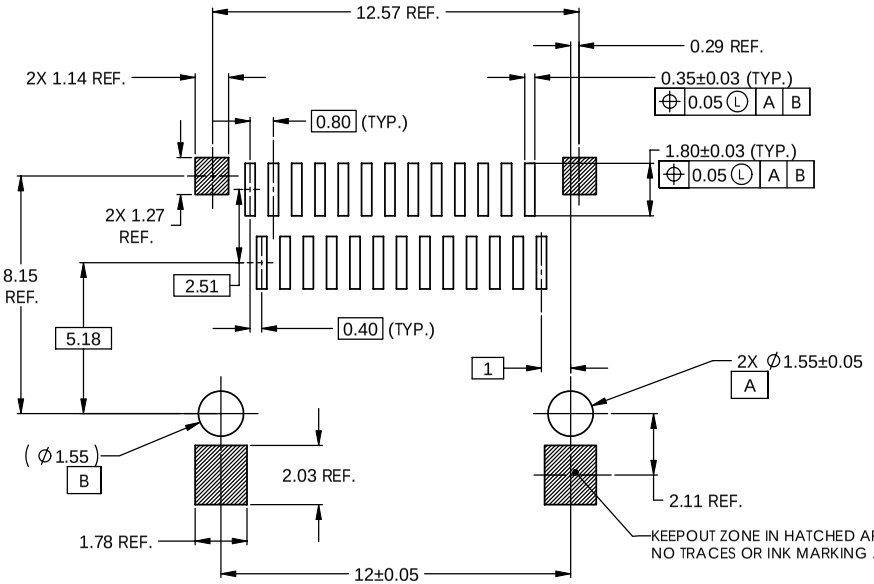








PART NUMBER	PACKAGING	CONTACT PLATING
FS1-R26-2000	TAPE AND REEL	30µ" GOLD OVER 50µ" NICKEL IN CONTACT AREAS 100µ" MATTE TIN OVER 50µ" NICKEL IN SOLDER AREAS
FS1-R26-3000		15µ" GOLD OVER 50µ" NICKEL IN CONTACT AREAS 100µ" MATTE TIN OVER 50µ" NICKEL IN SOLDER AREAS



RECOMMENDED PCB LAYOUT

NOTES:

1) MATERIAL:

HOUSING: SOLDER REFLOW PROCESS COMPATIBLE LCP, UL94V-0

CONTACTS: PHOSPHOR BRONZE

2) ROHS COMPLIANT

3) PERFORMANCE:

ELECTRICAL: 0.5 AMPS MAX. PER CONTACT

MECHANICAL: 250 MATING CYCLES MINIMUM

4) COMPLIES WITH SFF-8086

DO NOT SCALE DRAWING

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UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILIMETERS
TOLERANCES ARE:
DECIMALS ANGLES
.X± 0.25 ± 2°
.XX± 0.13
MATERIAL AND FINISH
ENG.REL.NO. EAR
CODE IDENT. NO. 03554

APPROVALS	DATE
DRAWN YK	15/FEB/06
DESIGNED YK	15/FEB/06
CHECKED	
QA APP'D	
E. APP'D	
DWG. APP'D	

Amphenol Canada Corp.

TITLE: SFF, 26 POSITION CONNECTOR

SIZE C | DWG. NO. P-FS1-R26-X000 | REV. J

SCALE NTS | PROJECT SFF | SHEET 1 OF 1